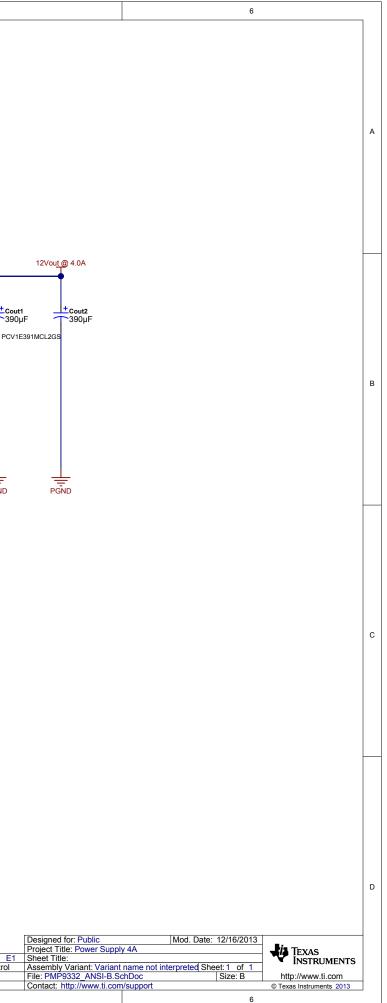
	1	2	3		4	5
A						
В			Ccomp2 Ccomp2 Ccomp1	PGND 7 Cec 0.22µF	M1 M3 4 60V 7 60V 84.5k 100pF 84.5k 100pF	Lout SRR1280-120M 12µH Decv
С		L C1=Cin C2=Csep C3=DNP C4=Ccomp1 C5=Ccomp2 C6=Cramp C7=Cc C8=Cbp C9,C10,C11=DNP C12=Cout	EGEND R2=Ruvlo2 J2=DNP R3=Ruvlo1 L1=Lin/Lout R4=DNP M1=Q1 R5=Rfb1 R6=Rfb2 R7=DNP R8=Rsense R9=Rcomp R10=Rfadj			
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